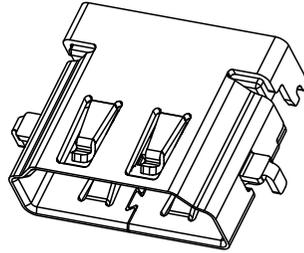
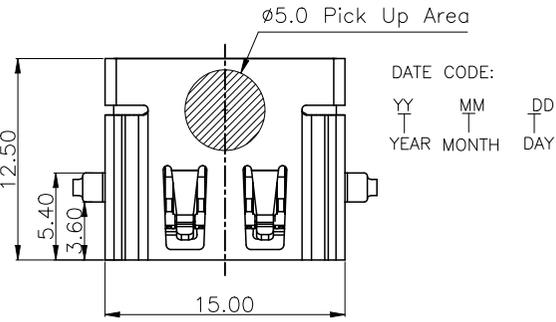
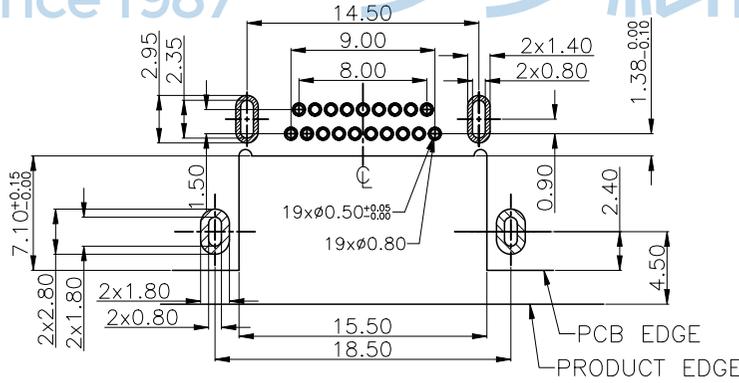
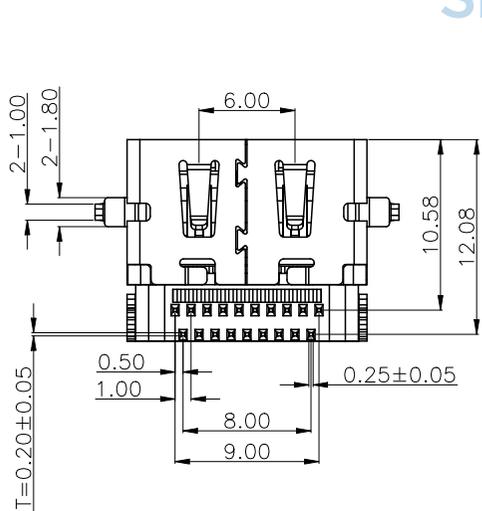
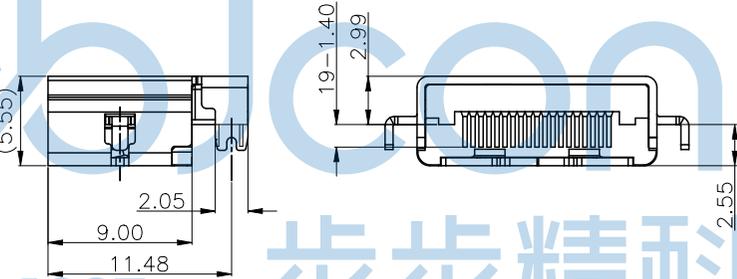
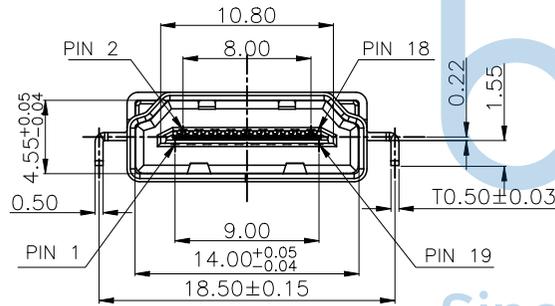


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	2022/10/20	TSP



NOTES:

- ELECTRONIC:
CONTACT RESISTANCE: 20mohm MAX
INSULATION RESISTANCE: 1000 Mohm MIN
WITHSTAND VOLTAGE: AC 500V,1min.
- MECHANICAL:
DURABILITY: 10000 CYCLE.
- ENVIRONMENT CHARACTERISTICS:
OPERATING TEMPERATURE: -55°C TO $+105^{\circ}\text{C}$
- RECOMMANDER PCB THICKNESS 1.2 TO 1.60MM
- DATA CODE: XXXXX



RECOMMENDED PCB LAYOUT T=1.20
GENERAL TOLERANCES: ± 0.05



MATERIAL LIST:

No.	PART NAME	QTY	MATERIAL	REMARK
3	SHELL	1	SUS 304 T=0.50	NI PLATED
2	CONTACT	19	COPPER ALLOY T=0.20	AU/TIN PLATED
1	HOUSING	1	THERMOPLASTIC LCP	(UL 94V-0) BLACK

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION. PDWG:NO: 0409-1

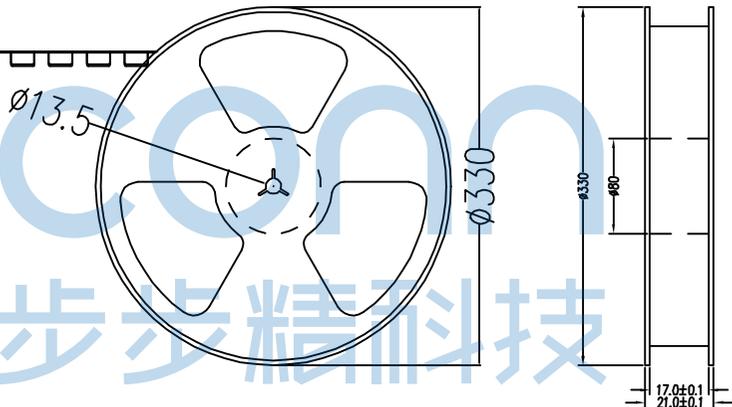
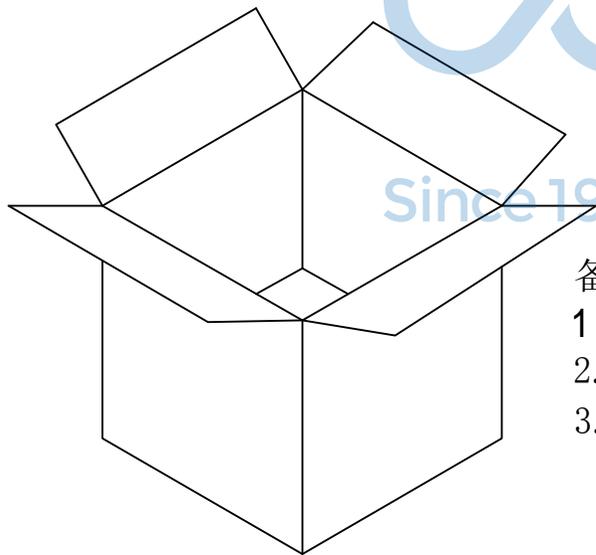
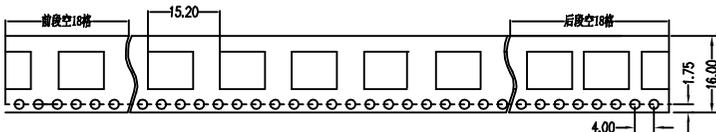
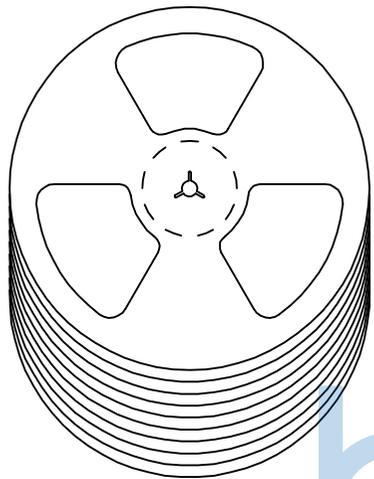
深圳市步步精科技有限公司

NAME:HDMI 19P A母 反向沉板2.55 DIP 四脚插 平口 不锈钢外壳 LCP黑胶 L=12.50 编带

APPD. JM_Zheng
CHKD. LYX
DR. TSP

PJ. NO.: 124-222-190002-H5G
SIZE: A4 | DRW NO.:
FINISH: SEE NOTES | MAT'L.: SEE NOTES
SCALE: N/A | REV.: A0 | UNIT: mm | PAGE: 1/2

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	2022/10/20	TSP



备注:

1. 包装数量：500/PCS/卷，10卷/箱
2. 包装袋长度：每卷前后各空10-20个空格，中间包装。
3. 材质：
载体：聚丙烯（PS），
上带：聚乙烯（PET），
卷盘：聚苯乙烯。

纸箱规格：345*345*23MM
纸箱规格：345*345*35MM

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
.X: ±0.38 .X': ±3" .XX: ±0.25 .X'': ±2" .XXX: ±0.13 .X''': ±1"		NAME:HDMI 19P A母 反向沉板2.55 DIP 四脚插 平口 不锈钢外壳 LCP黑胶 L=12.50 编带	
APPD.	JM_Zheng	PJ. NO.: 124-222-190002-H5G	
CHKD.	LYX	SIZE: A4 DRW NO.:	
PDWG.NO:	0409-1	DR.	TSP
		FINISH:	SEE NOTES
		MAT'L.:	SEE NOTES
		SCALE:	N/A
		REV.:	A0
		UNIT:	mm
		PAGE:	2/2